

Nashville, TN | Penang, Malaysia | Maldegem, Belgium | Manchester, NH | Shanghai, China

Solder Paste: Indium7.08 Revision Date: 5-Jan-2015 Process Type: Assembly Cleaning Aquanox® A4625 Aquanox® A4639 Aquanox[®] A4703

LEGEND	
5	Wrong Choice
4	Generally not usable for this purpose
3	Generally usable, but not the best choice
2	Generally qualified for this purpose
1	Especially made for this purpose

LEGEND		FEATURES & CLASSIFICATION
5	Wrong Choice	BiX Alloy - Replacement solder paste for high lead(Pb)
4	Generally not usable for this purpose	Halogen Free
3	Generally usable, but not the best choice	Formulated for dispense applications
2	Generally qualified for this purpose	IPC to J-STD-004B - ROH0
1	Especially made for this purpose	Material compatibility should be verified with every pro

CLEANING PROCESS			
	A4625	A4639	A4703
Flexible Printed Circuits	1	1	3
MIL-STD and Aerospace	1	1	3
Med-Rel Electronics	1	1	3
Double Sided SMT	1	1	3
Ceramic Hybrids	1	1	3
Advanced Packages	1	2	4
METHOD			
Cold Cleaning (CC)	4	4	4
Hot Liquid Cleaning (HLC)	1	1	1
Vapor Phase Cleaning (VPC)	5	5	5
Ultrasonic (US)	3	4	3
Spray Under Immersion (SUI)	3	4	4
Batch Spray In Air (SIA)	A4625B	1	1
Inline Spray in Air	1	2	1
Rework / Manual	4	4	4
PROCESS CAPABILITY			
Non Flash process	1	1	1
ECO Friendly process	2	2	2
Distillable process	5	5	5
Biodegradable process	2	2	2
Fast Drying	4	4	4
Solder Joint Appearance	1	2	1
Cosmetic cleanliness	1	1	1
DI Rinsing	1	1	1
Cleaning Before Conformal Coating	1	1	1
CONTROL METHOD			
Refractive Index	3	1	1
Titration	3	3	3
Phase Split Method	1	4	4
RELIABILITY			
Low Ionic contamination	1	1	1
No corrosion	1	2	2
High SIR	1	1	1

FEATURES & CLASSIFICATION
BiX Alloy - Replacement solder paste for high lead(Pb)
Halogen Free
Formulated for dispense applications
IPC to J-STD-004B - ROH0
Material compatibility should be verified with every process change.

CLEANING PROCESS				
	A4625	A4639	A4703	
Color	Amber	Clear	Straw	
Odor	Mild	Mild	Mild	
Flashpoint COC [drg c]	None to Boil	None to Boil	None to Boil	
Boiling point 1000 mBar [dgr C]	165-170°C	101°C	138°C	
VOC content - Method 24 [g/L]	942 g/L	615 g/L	900 g/L	
Surface tension 20 dgr C [dynes/cm]	31 dynes/cm	NE	30 dynes/cm	
DILUTED PROPERTIES				
pH as delivered	9.0-10.0	10.5-11.5	9.1-9.9	
Min concentration in water [% w/w]	5%	4%	3%	
Max concentration in water [% w/w]	20%	20%	20%	
pH @ 1.0% Solution	9.5	10.0	9.1	
Thinner	DI-water	DI-water	DI-water	
Recommended process temperature	40-65°C	50-65°C	50-65°C	
PRODUCT DOCUMENTATION				
RoHS Declaration of Conformity		Available		
REACH Declaration of Conformity		Available		
Certificates of Compliance and Analysis		Available		
Product Supplement	A	Available in Englis	h	
PACKAGING AND STORAGE				
Packaging can (HDPE) [liter / gallon]		5 / 1		
Packaging can (HDPE) [liter / gallon]		25 / 5		
Packaging Drum (HDPE) [liter / gallon]	200 / 55			
Recommended shelf-life	5-Years in Unopened Containers of 25L or more			
Storage temperature	Cool/Dry/Controlled Conditions			
Personal Handling Conditions				
Please refer to the product Safety Data Sheet (SDS) for complete safety information.				

- **XYZEN** is an ISO 9001:2008 certified company.
- KYZEN products DO NOT CONTAIN, in any amount, substances prohibited by EU Directive 2011/65/EU, Restriction of Hazardous Substances (RoHS).
- KYZEN products comply with EU Directive 1907/2006/EC, Registration, Evaluation, Authorization and Restriction of Chemicals (REACH) and DO NOT CONTAIN, in any amount, constituents defined by REACH as Substances of Very High Concern (SVHC).



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Solder Paste: Indium7.08 Revision Date: 5-Jan-2015

Process Type: Maintenance Cleaning

Cybersolv® C8502 Cybersolv® C8508 KYZEN® E5321

LEGEND	
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CLEANING PROCESS			
	C8502	C8508	E5321
Wave Solder Pallets	n/a	n/a	n/a
Wave Solder Fingers	n/a	n/a	n/a
Reflow Oven Interior	1	1	3
Reflow Oven Filters / Condenser	1	1	3
Flux Traps	1	1	3
Spray Fluxer	n/a	n/a	n/a
METHOD			
Cold Cleaning (CC)	1	1	1
Hot Liquid Cleaning (HLC)	3	3	2
Ready To Use	1	1	5
Ultrasonic (US)	1	1	1
Spray Under Immersion (SUI)	1	1	1
Batch Spray In Air (SIA)	4	4	2
Inline Spray in Air	4	4	3
Rework / Manual	1	1	3
PROCESS CAPABILITY			
Non Flash process	2	2	2
ECO Friendly process	2	2	3
Distillable process	5	5	5
Biodegradable process	2	2	2
Fast Drying	2	2	3
Solder Joint Appearance	4	4	4
Cosmetic cleanliness	1	1	1
DI Rinsing	2	2	1
Cleaning Before Conformal Coating	3	3	3
CONTROL METHOD			
Refractive Index	n/a	n/a	1
Titration	n/a	n/a	2
Phase Split Method	n/a	n/a	n/a
RELIABILITY			
Low Ionic contamination	4	4	4
No corrosion	2	2	2
High SIR	4	4	4

FEATURES & CLASSIFICATION	
BiX Alloy - Replacement solder paste for high lead(Pb)	
Halogen Free	
Formulated for dispense applications	
IPC to J-STD-004B - ROH0	
Material compatibility should be verified with every process change.	

	C8502	C8508	E5321	
Color	Colorless	Amber	Straw	
Odor	Mild	Mild	Mild	
Flashpoint COC [drg c]	None to Boil	None to Boil	None to Bo	
Boiling point 1000 mBar [dgr C]	>93°C	105°C	103°C	
VOC content - Method 24 [g/L]	503.2 g/L	339 g/L	477.4 g/L	
Surface tension 20 dgr C [dynes/cm]	28 dynes/cm	31 dynes/cm	30 dynes/c	
DILUTED PROPERTIES				
pH as delivered	11.0 - 12.0	9.0-11.0	>13	
Min concentration in water [% w/w]	Ready to use	Ready to use	3%	
Max concentration in water [% w/w]	Ready to use	Ready to use	10%	
pH @ 1.0% Solution	10.5	10.7	12.2	
Thinner	n/a	n/a	DI-water	
Recommended process temperature	20-60°C	Ambient	20-40°C	
PRODUCT DOCUMENTATION				
RoHS Compliance Certificate		Available		
REACH Compliance Certification		Available		
Certificates of Compliance and Analysis		Available		
Product Supplement	Į.	Available in Englis	h	
PACKAGING AND STORAGE				
Packaging can (HDPE) [liter / gallon]		5/1		
Packaging can (HDPE) [liter / gallon]		25 / 5		
Packaging Drum (HDPE) [liter / gallon]		200 / 55		
Recommended shelf-life	5-Years in Uno	5-Years in Unopened Containers of 25L or more		
Storage temperature	Cool/D	Cool/Dry/Controlled Conditions		
Personal Handling Conditions				

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Solder Paste: Indium7.08 Revision Date: 5-Jan-2015 Process Type: Solvent Cleaning

Ionox[®] I3302 Micronox[®] MX2501 Cybersolv® 141-R

LEGEND	
5	Wrong Choice
4	Generally not usable for this purpose
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CLEANING PROCESS				
		13302	MX2501	141-R
Flexible Printed Circuits		1	1	2
MIL STD	MIL STD and Agreepage 1 1 2			

	I3302	MX2501	141-R
Flexible Printed Circuits	1	1	2
MIL-STD and Aerospace	1	1	2
Med-Rel Electronics	1	1	2
Double Sided SMT	1	1	2
Ceramic Hybrids	1	1	2
Advanced Packages	1	1	2
METHOD			
Cold Cleaning (CC)	3	3	1
Hot Liquid Cleaning (HLC)	1	5	5
Vapor Phase Cleaning (VPC)	5	1	5
Ultrasonic (US)	2	2	5
Spray Under Immersion (SUI)	1	2	5
Batch Spray In Air (SIA)	4	5	5
Inline Spray in Air	4	5	5
Rework / Manual	3	5	1
PROCESS CAPABILITY			
Non Flash process	3	1	2
ECO Friendly process	2	2	3
Distillable process	3	1	2
Biodegradable process	2	4	3
Fast Drying	3	1	1
Solder Joint Appearance	1	1	1
Cosmetic cleanliness	1	1	1
DI Rinsing	2	5	5
Cleaning Before Conformal Coating	3	2	3
CONTROL METHOD			
Refractive Index	4	n/a	n/a
Titration	4	n/a	n/a
Phase Split Method	5	n/a	n/a
RELIABILITY			
Low Ionic contamination	1	2	2
No corrosion	2	1	1
High SIR	1	2	2

FEATURES & CLASSIFICATION	
BiX Alloy - Replacement solder paste for high lead(Pb)	
Halogen Free	
Formulated for dispense applications	
IPC to J-STD-004B - ROH0	
Material compatibility should be verified with every process change.	

CLEANING PROCESS				
	13302	MX2501	141-R	
Color	Straw	Colorless	Colorless	
Odor	Mild	Characteristic	Ethereal	
Flashpoint COC [drg c]	82°C	None to Boil	None to Boil	
Boiling point 1000 mBar [dgr C]	150°C	44°C	47°C	
VOC content - Method 24 [g/L]	1034.9 g/L	878 g/L	1175 g/L	
Surface tension 20 dgr C [dynes/cm]	32 dynes/cm	24 dynes/cm	26 dynes/cm	
DILUTED PROPERTIES				
pH as delivered	9.5-10.4	Neutral	Neutral	
Min concentration in water [% w/w]	Ready to use	Ready to use	Ready to use	
Max concentration in water [% w/w]	Ready to use	Ready to use	Ready to use	
pH @ 1.0% Solution	9.9	n/a	n/a	
Thinner	n/a	n/a	n/a	
Recommended process temperature	40-60°C	44-46°C	Ambient	
PRODUCT DOCUMENTATION				
RoHS Compliance Certificate		Available		
REACH Compliance Certification		Available		
Certificates of Compliance and Analysis		Available		
Product Supplement	A	Available in Englis	h	
PACKAGING AND STORAGE				
Packaging can [kg / pound]	5/1(HDPE) [l/g]	/g] 4/9 (Steel)		
Packaging can [kg / pound]	25/5(HDPE) [I / g]	20/45	(Steel)	
Packaging drum [kg / pound]	200/55(HDPE) [I / g	200/55(HDPE) [I / g 200/440(Steel)		
Recommended shelf-life	5-Years in Unop	5-Years in Unopened Containers of 25L or more		
Storage temperature	Cool/D	Cool/Dry/Controlled Conditions		
Personal Handling Conditions				
Please refer to the product Safety Data	Sheet (SDS) for com	plete safety inform	nation.	

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Solder Paste: Indium7.08 Revision Date: 5-Jan-2015 Process Type: Stencil Cleaning

KYZEN[®] E5611 Cybersolv® C8882 Aquanox[®] A8820

LEGEND	
5	Wrong Choice
4	Generally not usable for this purpose
3	Generally usable, but not the best choice
2	Generally qualified for this purpose
1	Especially made for this purpose

LEGEND		FEATURES & CLASSIFICATION
5	Wrong Choice	BiX Alloy - Replacement solder pa
4	Generally not usable for this purpose	Halogen Free
3	Generally usable, but not the best choice	Formulated for dispense application
2	Generally qualified for this purpose	IPC to J-STD-004B - ROH0
1	Especially made for this purpose	Material compatibility

CLEANING PROCESS			
	E5611	C8882	A8820
Under Stencil Wipe Cleaning	4	1	5
Squeegies / Blades / Hardware	1	1	1
Stencils Poly - Pump Print	1	1	1
Stencils Metal	1	1	1
Single Side Misprint	2	2	2
Double Side Misprint	2	4	4
Uncured SMT Adhesives	1	1	3
METHOD			
Cold Cleaning (CC)	2	1	3
Hot Liquid Cleaning (HLC)	1	2	1
Ready to use available	Yes	1	Yes
Ultrasonic (US)	2	2	4
Spray Under Immersion (SUI)	2	2	3
Batch Spray In Air (SIA)	1	5	1
Inline Spray in Air	3	5	3
PROCESS CAPABILITY			
Non Flash process	2	1	1
ECO Friendly process	1	1	2
Distillable process	5	5	5
Biodegradable process	2	2	2
Fast Drying	3	2	4
Solder Joint Appearance	1	1	1
Cosmetic cleanliness	2	2	1
DI Rinsing	2	2	2
Cleaning Before Conformal Coating	3	3	3
CONTROL METHOD			
Refractive Index	1	n/a	5
Titration	4	n/a	5
Phase Split Method	2	n/a	1
RELIABILITY			
Low Ionic contamination	2	2	1
No corrosion	1	2	2
Nano Coating Safe	1	1	1

FEATURES & CLASSIFICATION	
BiX Alloy - Replacement solder paste for high lead(Pb)	
Halogen Free	
Formulated for dispense applications	
IPC to J-STD-004B - ROH0	
Material compatibility should be verified with every process change.	

	E5611	C8882	A8820	
Color	Colorless	Colorless	Colorless	
Odor	Mild citrus	Mild	Mild	
Flashpoint COC [drg c]	None to Boil	61°C	>93°C	
Boiling point 1000 mBar [dgr C]	103°C	132°C	144°C	
VOC content - Method 24 [g/L]	822 g/l	875.6	884.5 g/L	
Surface tension 20 dgr C [dynes/cm]	36	NE	28	
DILUTED PROPERTIES				
pH as delivered	Neutral	N/A	N/A	
Min concentration in water [% w/w]	20%	Ready to use	N/A	
Max concentration in water [% w/w]	100%	Ready to use	25%	
pH @ 1.0% Solution	7.0	N/A	N/A	
Thinner	DI-water	N/A	Di-water	
Recommended process temperature	20-45°C	Ambient	20-45°C	
PRODUCT DOCUMENTATION				
RoHS Compliance Certificate		Available		
REACH Compliance Certification		Available		
Certificates of Compliance and Analysis		Available		
Product Supplement	A	Available in Englis	h	
PACKAGING AND STORAGE				
Packaging can (HDPE) [liter / gallon]		5 / 1		
Packaging can (HDPE) [liter / gallon]		25 / 5		
Packaging Drum (HDPE) [liter / gallon]		200 / 55		
Recommended shelf-life	5-Years in Uno	5-Years in Unopened Containers of 25L or mor		
Storage temperature	Cool/D	ry/Controlled Con	ditions	
Personal Handling Conditions				

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